コモンモードチョークコイル (DC、信号ライン用) SMDタイプ **COMMON MODE CHOKE COILS** (FOR DC AND SIGNAL LINES) SMD TYPE

	OPERAT	ΓING TEMP.	-25~+105°C	: (製品自己発	熱を含む)
			(Including	self-generate	d heat)
等価回路 Equivalent circuits	CM04RC (2 Lines) Type 4 3	CM04RC (3 Lines) Type (6 (5 4) 1007 (1) (2 (3)	CM04RC (4 Lines) Type (8 (7) (6) (7007) (9) (8) (7) (7007) (9)	BU05MC (2 Lines) Type (a) (a) (b) (b) (c) (c) (c) (d) (d) (d) (d) (d) (d) (d) (d) (d) (d	BU05MC (3 Lines) Type (6 (9 100) (9 3)





FEATURES

CM04RC•BU05MC

- ·SMT対応
- ・高結合なコイル構造によりコモンモードノイズの除去に最適

CM04CR / BU05MC

- · Available in embossed tape and reel.
- Highly coupled coil construction ideal for common mode noise attenuation

用途 APPLICATIONS

- ・多機能電話機,PBX、FAXなど外線の不要幅射電界および放送波に対するイ ミュニティ対策
- ・各種電子機器のDCラインのノイズ対策
- ・ACアダプタ、バッテリーチャージャー及び各種デジタル機器の電源2次側 ライン、信号ラインの不要幅射対策
- ・DVC,DSC等の電源、2次側DCラインの不要輻射対策。 ・パーソナルコンピューター、プリンター、スキャナー等のUSB(D+,D-)及 びIEEE1394の高速差動伝送のノイズ除去。
- · Immunity against undesirable external line radiation fields and broadcast waves generated by multifunction telephone sets, PBXs, and facsimile ma-
- · Preventive measure against DC line noise in electronic equipment.
- Suppresses radiated emissions from secondary power supplies and signal lines on AC adapters, battery chargers, and digital equipment.
- Excellent for reducing radiated noise in DVC (digital video cameras) and DSC (digital still cameras)
- Offers high speed differential mode noise attenuation in USB and IEEE1394 connectors in personal computers, printers, scanners and other computer peripherals

形名表記法 ORDERING CODE

形式	
CM	コモンモードチョークコイル
BU	1

形状	
RC	
MC	面実装タイプ



包装記号 テーピング品

コアの長辺寸法(mm)		
04	3.5	
05	5.0	





Type	
CM	Common mode choke coils
BU	Common mode choke cons

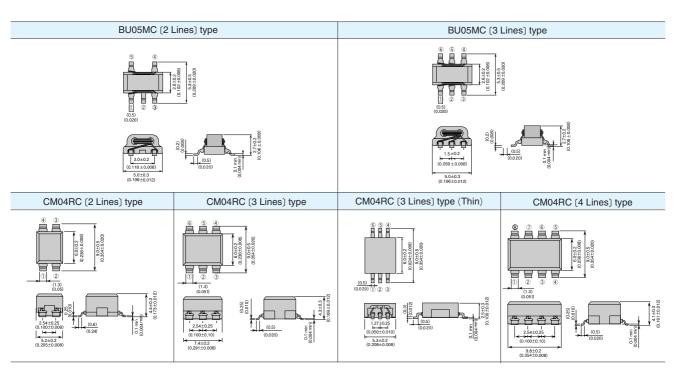
Shape)
RC	Cf
MC	Surface mount type

Product classification code 01 to 13

Packaging Taped products

Dimensions of Core(dia.)(mm)		
04 3.5		
05	5.0	





公差のない数値は参考値です。 The values without tolerance are for reference only.

アイテム一覧 PART NUMBERS

CM04RCタイプ

形名 Ordering code	ライン数 No. of Lines	インピーダンス Impedance [Ω]	直流抵抗 DC resistance [Ω]	定格電流 Rated current [A]	[V]	絶縁抵抗 Insulation resistance [MΩ]
	140. OI LINES	(typical)	(max.)	(max.)	(Ď.Č.)	(min.)
CM04RC01T		800 (at 100MHz)	0.06	1.5		
CM04RC03T	2	500 (at 480MHz)	0.06	2.0		
CM04RC04T		900 (at 15MHz)	0.1	1.0		
CM04RC07T		500 (at 160MHz)	0.06	2.5	F0	100
CM04RC09T		270 (at 200MHz)	0.03	3.0	50	100
CM04RC10T		100 (at 200MHz)	0.02	4.0		
CM04RC02T	3	1000 (at 100MHz)	0.18	0.5		
CM04RC08T(THIN)	3	1000 (at 200MHz)	0.2	0.5		
CM04RC05T	4	800 (at 100MHz)	0.2	0.5		

BU05MCタイプ

0001107 17						
形名 Ordering code	ライン数 No. of Lines	インピーダンス Impedance [Ω] (typical)	直流抵抗 DC resistance [Ω] (max.)	定格電流 Rated current [A] (max.)	定格電圧 Rated voltage [V] (D.C.)	絶縁抵抗 Insulation resistance [MΩ] (min.)
BU05MC01T		1000 (at 60MHz)	0.12	1		
BU05MC03T		600 (at 100MHz)	0.10	1.5		
BU05MC05T	2	1700 (at 130MHz)	0.12	1		
BU05MC07T		1200 (at 250MHz)	0.11	1	50	100
BU05MC13T		1000 (at 200MHz)	0.06	1	30	100
BU05MC02T		1000 (at 150MHz)	0.15	0.5		
BU05MC08T	3	700 (at 60MHz)	0.11	0.5		
BU05MC11T		800 (at 350MHz)	0.09	0.5		

セレクションガイド Selection Guide



アイテム一覧 Part Numbers



特性図 Electrical Characteristics



梱包 Packaging



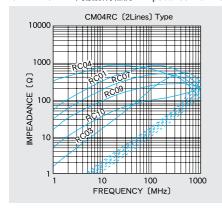
信頼性 Reliability Data

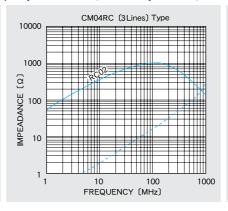


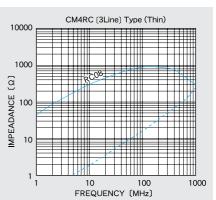
使用上の注意 Precautions

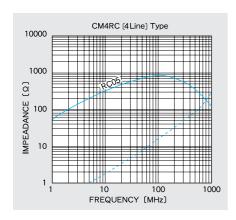


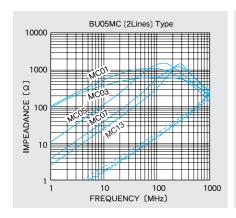
インピーダンス周波数特性例 Impedance -vs- Frequency characteristics(Measured by HP4291A)

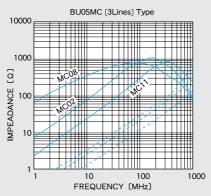








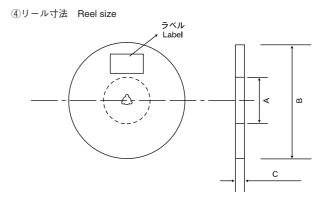




----- コモンモード ----- ノーマルモード

①標準数量 Standard quantity

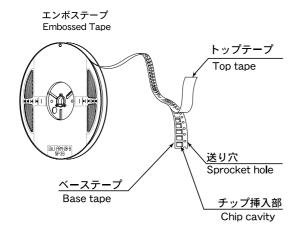
	標準数量 (pcs.)	
Type	Standard quantity	
Туре	テーピング	
	Taping	
CM04RC [2 Lines] type	1500	
CM04RC [3 Lines] type	1000	
CM04RC [3 Lines] type (Thin)	2500	
CM04RC [4 Lines] type	1000	
BU05MC [2 Lines] type	2500	
BU05MC [3 Lines] type	2500	



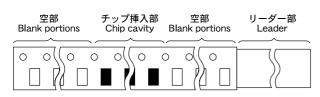
Type	А	В	С
CM04DC	φ100±1	φ330±2	18±1.5
CM04RC	(\$\phi 3.94\pm 0.039)	(<i>ϕ</i> 12.99±0.079)	(0.709 ± 0.059)
BU05MC	φ80±1	φ330±2	13.5±1
BOUSIVIC	(\$\phi 3.15\pm 0.039)	(<i>ϕ</i> 12.99±0.079)	(0.53 ± 0.039)

Unit: mm(inch)

②テーピング材質 Tape Material



③リーダー部・空部 Leader and Blank Portion

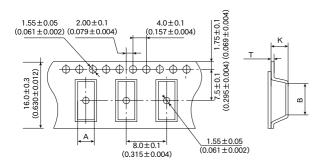


引き出し方向 Direction of tape feed

Туре	リーダー部 Leader	空部 (リーダー部側) Blank portions (Leader side)	空部 (チップ挿入部側) Blank portions (Chip cavity side)
CM04RC	150(5.89)	80(3.14)	80(3.14)
BU05MC	150(5.89)	80(3.14)	80(3.14)

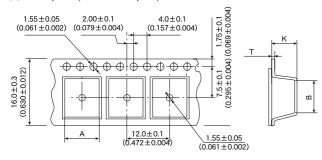
Unit: mm(inch)

エンボステープ (CM04RCタイプ) Embossed tape (CM04RC type) (1) 8mm pitch (0.31 inches pitch)

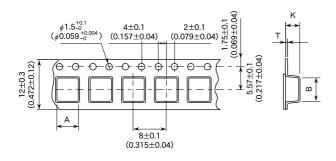


Type ライン数 Lines		挿入ピッチ Insertion		挿入部 cavity	テープ厚み Tape thickness		
	Lines	pitch	Α	В	K	T	
	2	8.0±0.1	5.7±0.1	9.65±0.1	5.2max	0.4±0.05	
CM04RC	3	12.0±0.1	9.8±0.1	7.7±0.1	5.0max	0.38±0.05	
CIVIU4HC	3 (THIN)	8.0±0.1	5.7±0.1	9.8±0.1	3.1max	0.4±0.05	
	4	12.0±0.1	10.3±0.1	10.3±0.1	5.0max	0.3±0.05	
BU05MC	2	8.0±0.1	5.35±1.5	5.7±0.2	3.2±0.1	0.4±0.05	
BU05MC	3	0.0±0.1	3.33 1.3	3.7 ±0.2	J.Z±U.1	0.4_0.05	

(2) 12mm pitch (0.472 inches pitch)

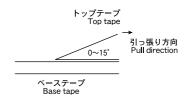


エンボステープ (BU05MCタイプ) Embossed tape (BU05MC type)



⑥トップテープ強度 Top Tape Strength

トップテープのはがし力は、下図矢印方向にて0.1~0.7Nとなります。 The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illutrated below.



			Specifled Value						
ltem	Surface Mount High current inductors 08 Type	Surface Mount High current inductors 04/05/06 Type	CommonMode Choke Coils CM04RC	CommonMode Choke Coils BU05MC	Balun Transformers BU05MC	Test N	lethod and Rei	marks	
1.Operating Temperature Range	-25°C~+85°C	-25~+105°C				Including self-generat	ed heat		
2.Storage Temperature Range	-40°C~+85°C					Commom mode chok		ansformers:	
3.Rated current	Within the specifica	ation	Within the specified	l tolerance		MSD inductor: The maximum DC val within specified value 40°C by the application	ue having indu		
						Inductance decrease	05	06	
						30% Commom mode chok	20%	10%	
						The maximum DC value fied temperature,as deta	naving temperatu		
4.Impedance			Within the specified	l tolerance		Commom mode chok Measuring equipment	: HP 4291A o		ent
5. Inductance	Within the specified	t tolerance			Refer to individual	Measuring frequency SMD inductor:	Specified free	quency	
5. Inductance	within the specified	tolerance			specification	Measuring equipment	. HD 43844 o	r ite equivale	ınt
					орестоиноп	Measuring frequency		i ito equivale	
						Measuring voltage: 1V		ent in series o	onnection
6.DC Resisitance	Within the specified	d tolerance			1	SMD transformer • SMD			
						Measuring equipment			
7.Self resonance frequency	Within the specifica	ation				SMD inductor :			
						Measuring equipment	: Impedance a	analyzer	
						(HP 4191A, 4192A) o	r its equivalent	t	
8.Temperature characteris-	04, 05, 06 Type: V	Vithin ±10%				SMD inductor:			
tic	08Type: Within±5	%				Change of maximum	nductance dev	viation in ste	o 1 to 5
						Temperature at s	tep 1 20°C		
						Temperature at s	tep 2	num operatir erature	ng
						Temperature at s		Standard tem	
						Temperature at s	tep 4	mum oparati erature	ng
						Temperature st s	tep 5 20°C		
9.Resisitance to flexure of			Can satisfy the con	ditions of the chart a	at right.	Commom mode chok	e coil:		
substrare						Accoding to JIS C005			
							CM04RC · E		
						Warp	3mn		
						Pressing speed	0.5mm/		
						Duration	5±1s	ec.	
						Pr	essig jig		
						1 R5	R340 (t=1mm) Board	<u> </u>	
						H5 45±2m	m → 45±2mm	 	

			Specifled Value					
ltem	Surface Mount High current inductors 08 Type	Surface Mount High current inductors 04/05/06 Type	CommonMode Choke Coils CM04RC	CommonMode Choke Coils BU05MC	Balun Transformers BU05MC		Test Method	d and Remarks
10.Standard donndityonn	referred to herein is 5 to 35°C of tempera When there are que In order to provide of ture, 45 to 85% rela	ondition: "standard or a defined as follows: ature, 45 to 85% rela estions concerning m correlation data, the to tive humidity and 86 opecified, all the tests	tive humidity and 86 easurement results: est shall be conducte to 106kPa of air pre	ed under condition of ssure.	20±2°C of tempera-			
11.Insulation resistance: between wires	100MΩ min.				SMD inductor: Applied voltage Commom mode	: 100VDC	Duration : 60sec.	
						Applied voltage		tage
12.Insulation resistance:	100MΩ min.					SMD inductor:	50.	
between wire and core						Applied voltage	: 100VDC	Duration: 60sec.
13.Rated current			Within the specifica	ition				
14.Withstanding voltage: between wires			No abnormality			Commom mode Applied voltage Duration: 60 se	Regulation	
15.Withstanding voltage: between wire and core	No abnormality					SMD inductor: Applied voltage Duration: 60 se		
16.Adhesion of terminal electrode	No abnormality						and apply sp	o top surface of specimen mounted recified static load for 5 sec.
17.Resisitance to vibration	Impedance change	∶ Within:±5%	Refer to individual s	specification.		Frequency rai Amplitude: 1.5 Mounting met Recovery: At	rs each in X, nge: 10 to 5 mm (Shall no thod: solder t least 2 hrs ondition after urement with	Y, and Z directions. Total: 6 hrs 55 to 10 Hz (1 min.) or texceed acceleration 196m/s²) ring onto printed board of recovery under the standard or the test, followed by the mea-
18.Solderability	95% or more of mo shall be covered wi	unting terminal side th tresh solder.	At least 75% of te covered by new sol			SMD inductor Solder tempe Duration: 2± Immersion de Commom mode Solder temp Durati Immersior	c0.5 sec. epth : All sid be immediate choke coil perature	les of mounting terminal shall mersed.

			Specifled Value					
Item	Surface Mount High current inductors 08 Type	Surface Mount High current inductors 04/05/06 Type	CommonMode Choke Coils CM04RC	CommonMode Choke Coils BU05MC	Balun Transformers BU05MC		Test Method and F	Remarks
19.Resisitance to soldering heat	No abnormality		Refer to individual s			Recovery Commom ¶ Reflow Preheat Peak: Number Q Manual Solder t	Recommended reflow Recomm	w conditions 230°C n ax 10 150 150 200 ion (sec.) very under the standard oval from test chamber, arement within 24 hrs. 2 2min. sec. n 40 sec.
						Recove	ry: 1 to 2 hrs of recov	ery under the standard test.
20.Thermal shock	Inductance change: W	vittinin . ±10%	Refer to individual s	респісаціон.		SMD induc Step 1 2 3 4 SMD induc Step 1 2 3 4 Number of Recovery Commom Accoding t Conditions	o JIS C0025 ctor(08 type) Conditions of 1 c Temperature(°C) -25+0/3 Room temperature +85+2/2 Room temperature ctor(04, 05, 06 type) Conditions of 1 c Temperature(°C) -25+0/3 Room temperature +105+0/2 Room temperature cycyle: 10 cycles At least 2 hrs of reco condition after the rem followed by the measu mode choke coil: o JIS C0025 of 1 cycle Temperature(°C) CM04RC · BU05MC -25±3°C Room temperature 85±2°C Room temperature cycyle: 10 cycles	Duration(min) 30±3 Within 3 30±3 Within 3 Vycle Duration(min) 30±3 Within 3 Within 3 Within 3 Vry under the standard oval from test chamber, urement within 24 hrs. Duration(min) 30±3 30±3 3 30±3 3 ander the standard condi-

			Specifled Value					
			Specified value		1	_		
Item	Surface Mount High current inductors 08 Type	Surface Mount High current inductors 04/05/06 Type	CommonMode Choke Coils CM04RC	CommonMode Choke Coils BU05MC	Balun Transformers BU05MC	Test	Method and Remarks	
21.Damp heat (steady state)			Refer to individual	specification.		Commom mode chol	ke coil:	
							CM04RC · BU05MC	
						Temperature	40±2℃	
						Humidity	90~95%	
						Duration	1000±24	
	Inductance change:	Within * +10%	Refer to individual	specification	I	SMD inductor:		
22.Loading under damp near	inductance change :	WIUIII1 • ±10/0	Tieler to individual	specification.		Temperature: 40±2	°C	
						Humidity: 90~95%		
						Applied current : Rat	ed current	
						Duration: 240±2hrs		
						Recovery: At least	2 hrs of recvery under the s	standard
						condition	after rhe removal from test of	hamber,
						followed	by the measurement within 2	24 hrs.
						Commom mode chol	ke coil:	
							CM04RC · BU05MC	
						Temperature	40±2℃	
						Humidity	90~95%	
						Applied current	Rated current	
						Duration	1000±24	
							of recovery under the standar	
			5				the removed from test cham	iber
23.High temperature life test	Inductance change: V	Within: ±10%	Refer to individual	specification.		SMD inductor:		
						Temperature : SMD inductor : 10	5+2°C	
						Duration:	<u>5-3C</u>	
						SMD inductor : 24	0+2hrs	
							2 hrs of recvery under the s	standard
							after rhe removal from test of	
							by the measurement within 2	
						Commom mode chol	ke coil:	
							CM04RC · BU05MC	
						Temperature	85±2℃	
						Duration	1000±24	
						Recovery: 1~2 hrs	of recovery under the standar	rd condi-
						tion after	the removed from test cham	ber
24.Low Temperature life Test	Inductance change: V	Within: ±10%	Refer to individual	specification.		SMD inductor:		
						Temperature : -40∃	:3℃	
						Duration:		
						SMD inductor : 24		
							2 hrs of recvery under the s	
							after rhe removal from test of by the measurement within 2	
						Commom mode chol	ke coil:	
							CM04RC · BU05MC	
						Temperature	-40±3℃	
						Duration	1000±24	
						Recovery: 1~2 hrs	of recovery under the standar	rd condi-
						tion after	the removed from test cham	ber

SMD Inductors, CM04RC, BU05MC

Stages	Precautions	Technical considerations
100000	O	
1.Circuit Design	Operating environment,	
	1.The products described in this specification are intended for	
	use in general electronic equipment,(office supply	
	equipment, telecommunications systems, measuring	
	equipment, and household equipment). They are not	
	intended for use in mission-critical equipment or systems	
	requiring special quality and high reliability (traffic systems,	
	safety equipment, aerospace systems, nuclear control	
	systems and medical equipment including life-support	
	systems,) where product failure might result in loss of life,	
	injury or damage. For such uses, contact TAIYO YUDEN	
	Sales Department in advance.	
2.PCB Design	Land pattern design	
	1.Please contact any of our offices for a land pattern, and refer	
	to a recommended land pattern of specifications.	
3.Considerations for	Adjustment of mounting machine	
automatic placement	1.Excessive impact load should not be imposed on the	When installing products, care should be taken not to apply distortion stress as it n
	products when mounting onto the PC boards.	deform the products.
	2.Mounting and soldering conditions should be checked	
	beforehand.	
4.Soldering	Reflow soldering	
	1.Please contact any of our offices for a reflow soldering, and	1.If products are used beyond the range of the recommended conditions, heat stres
	refer to the recommended condition specified.	may deform the products, and consequently degrade the reliability of the products.
	2.This products is reflow soldering only.	
	3.SMD Inductors	
	Please do not add any stress to a product until it returns in	
	normal temperature after reflow soldering.	
	Lead free soldering	
	Nhen using products with lead free soldering, we request to	
	use them after confirming of adhesion, temperature of	
	resistance to soldering heat, soldering etc sufficiently.	
	Recommended conditions for using a soldering iron:	
	Put the soldering iron on the land-pattern.	
	Soldering iron's temperature - Below 350 ℃	
	Duration - 3 seconds or less	
5 Oleanian	The soldering iron should not directly touch the inductor.	
5.Cleaning	Cleaning conditions	
	1.SMD Inductors	
C. I. I. a. a. III. a.	Please contact any of our offices for a cleaning,	
6.Handling	Handling	A The control of the
	1.Keep the product away from all magnets and magnetic	1.There is a case that a characteristic varies with magnetic influence.
	objects.	
	Breakaway PC boards (splitting along perforations)	
	1. When splitting the PC board after mounting product, care	1.Planning pattern configurations and the position of products should be caref
	should be taken not to give any stresses of deflection or	performed to minimize stress.
	twisting to the board.	
	2.Board separation should not be done manually, but by using	
	the appropriate devices.	
	Mechanical considerations	
	1.Please do not give the product any excessive mechanical	1.There is a case to be damaged by a mechanical shock.
	shocks.	
	2.SMD Inductors	2.SMD Inductors
	Please do not add any shock and power to a product in	There is a case to be broken by the handling in transportation.
	transportation.	
	Pick-up pressure	
	1.SMD Inductors	1.SMD Inductors
	Please do not push to add any pressure to a winding part.	Damage and a characteristic can vary with an excessive shock or stress.
	Please do not give any shock and push into a ferrite core	,
	exposure part.	
	Packing	
	1.SMD Inductors	
		1 There is a case that transformation and a product of tape are demanded
	Please avoid accumulation of a packing box as much as possible.	1.There is a case that transformation and a product of tape are damaged accumulation of a packing box.
7.Storage conditions	Storage	accamination of a packing 50%.
7.Storage conditions		
	1.To maintain the solderability of terminal electrodes and to	d linda a bish tananahan and basidib. and sanah mahlama alah a sah
	keep the packing material in good condition, temperature	Under a high temperature and humidity environment, problems such as redu
	and humidity in the storage area should be controlled	solderability caused by oxidation of terminal electrodes and deteriora
	Recommended conditions	of taping/packaging materials may take place.
	Ambient temperature 0~40°C	
	Humidity Below 70% RH	
	The ambient temperature must be kept below 30°C. Even	
	under ideal storage conditions, solderability of products	
	electrodes may decrease as time passes. For this reason,	
	product should be used within one year from the time of	
	delivery.	
	In case of storage over 6 months, solderability shall be	